DATA SHEET WWW.DZSC.COM 74ABT126 Quad buffer (3-State)

INTEGRATED CIRCUITS

Product specification Supersedes data of 1996 Feb 26 IC23 Data Handbook

1998 Jan 16







Product specification

Quad buffer (3-State)

74ABT126

FEATURES

- Quad bus interface
- 3-State buffers
- Live insertion/extraction permitted
- Output capability: +64mA/–32mA
- Latch-up protection exceeds 500mA per JEDEC Std 17
- ESD protection exceeds 2000V per MIL STD 883 Method 3015 and 200V per Machine Model
- Power-up 3-State
- Inputs are disabled during 3-State mode

QUICK REFERENCE DATA

DESCRIPTION

The 74ABT126 high-performance BiCMOS device combines low static and dynamic power dissipation with high speed and high output drive.

The 74ABT126 device is a quad buffer that is ideal for driving bus lines. The device features four Output Enables (OE0, OE1, OE2, OE3), each controlling one of the 3-State outputs.

SYMBOL	PARAMETER	CONDITIONS T _{amb} = 25°C; GND = 0V	TYPICAL	UNIT
t _{PLH} t _{PHL}	Propagation delay An to Yn	$C_L = 50 pF; V_{CC} = 5V$	2.9	ns
C _{IN}	Input capacitance	$V_I = 0V \text{ or } V_{CC}$	4	pF
C _{OUT}	Output capacitance	Outputs disabled; V _O = 0V or V _{CC}	7	pF
I _{CCZ}	Total supply current	Outputs disabled; V _{CC} = 5.5V	65	μΑ

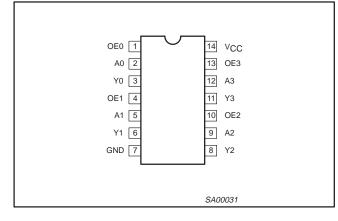
ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
14-Pin Plastic DIP	-40°C to +85°C	74ABT126 N	74ABT126 N	SOT27-1
14-Pin plastic SO	-40°C to +85°C	74ABT126 D	74ABT126 D	SOT108-1
14-Pin Plastic SSOP Type II	-40°C to +85°C	74ABT126 DB	74ABT126 DB	SOT337-1
14-Pin Plastic TSSOP Type I	-40°C to +85°C	74ABT126 PW	74ABT126PW DH	SOT402-1

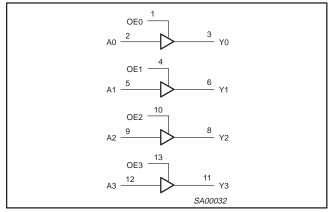
PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
2, 5, 9, 12	A0 – A3	Data inputs
3, 6, 8, 11	Y0 – Y3	Data outputs
1, 4, 10, 13	OE0 – OE3	Output enable inputs
7	GND	Ground (0V)
14	V _{CC}	Positive supply voltage

PIN CONFIGURATION



LOGIC SYMBOL



74ABT126

OUTPUTS

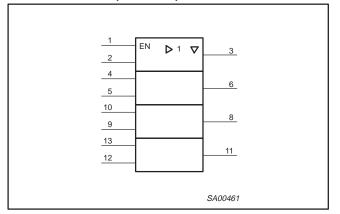
Yn

L

Н

Ζ

LOGIC SYMBOL (IEEE/IEC)



ABSOLUTE MAXIMUM RATINGS^{1, 2}

SYMBOL PARAMETER CONDITIONS RATING UNIT DC supply voltage -0.5 to +7.0 V Vcc DC input diode current -18 I_{IK} $V_{I} < 0$ mΑ Vı DC input voltage³ -1.2 to +7.0 V DC output diode current $V_{\rm O} < 0$ -50 mΑ I_{OK} V Vout DC output voltage³ output in Off or High state -0.5 to +5.5 DC output current output in Low state 128 mΑ I_{OUT} T_{stg} Storage temperature range -65 to 150 °C

FUNCTION TABLE

OEn

Н

Н

L

H = High voltage level

L = Low voltage level

Z = High impedance "off" state

= Don't care

Х

INPUTS

An

L

Н

Х

NOTES:

Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the 1. device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction 2. temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.
The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIM	ITS	UNIT
STWBOL	FARAMEIER	Min	UNIT	
V _{CC}	DC supply voltage	4.5	5.5	V
VI	Input voltage	0	V _{CC}	V
V _{IH}	High-level input voltage	2.0		V
V _{IL}	Low-level Input voltage		0.8	V
I _{ОН}	High-level output current		-32	mA
I _{OL}	Low-level output current		64	mA
Δt/Δv	Input transition rise or fall rate	0	10	ns/V
T _{amb}	Operating free-air temperature range	-40	+85	°C

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					LIMITS			
SYMBOL	PARAMETER	TEST CONDITIONS	T _{amb} = +25°C			T _{amb} = −40°C to +85°C		
			Min	Тур	Max	Min	Max	1
V _{IK}	Input clamp voltage	$V_{CC} = 4.5V; I_{IK} = -18mA$		-0.9	-1.2		-1.2	V
		V_{CC} = 4.5V; I_{OH} = –3mA; V_{I} = V_{IL} or V_{IH}	2.5	2.9		2.5		V
V _{OH}	High-level output voltage	V_{CC} = 5.0V; I_{OH} = –3mA; V_{I} = V_{IL} or V_{IH}	3.0	3.4		3.0		V
		V_{CC} = 4.5V; I_{OH} = –32mA; V_{I} = V_{IL} or V_{IH}	2.0	2.4		2.0		V
V _{OL}	Low-level output voltage	V_{CC} = 4.5V; I_{OL} = 64mA; V_{I} = V_{IL} or V_{IH}		0.35	0.55		0.55	V
I _I	Input leakage current	V_{CC} = 5.5V; V_I = GND or 5.5V		±0.01	±1.0		±1.0	μΑ
I _{OFF}	Power-off leakage current	V_{CC} = 0.0V; V_O or $V_I \le 4.5V$		±5.0	±100		±100	μA
I _{PU} /I _{PD}	Power-up/down 3-State output current ³	$V_{CC} = 2.1V; V_O = 0.5V; V_I GND \text{ or } V_{CC};$ $V_{OE} = Don't \text{ care}$		±5.0	±50		±50	μA
I _{OZH}	3-State output High current	V_{CC} = 5.5V; V_{O} = 2.7V; V_{I} = V_{IL} or V_{IH}		1.0	50		50	μA
I _{OZL}	3-State output Low current	V_{CC} = 5.5V; V_{O} = 0.5V; V_{I} = V_{IL} or V_{IH}		-1.0	-50		-50	μA
I _{CEX}	Output High leakage current	V_{CC} = 5.5V; V_{O} = 5.5V; V_{I} = GND or V_{CC}		5.0	50		50	μA
Ι _Ο	Output current ¹	$V_{CC} = 5.5V; V_{O} = 2.5V$	-50	-100	-180	-50	-180	mA
I _{CCH}		V_{CC} = 5.5V; Outputs High, V_{I} = GND or V_{CC}		65	250		250	μA
I _{CCL}	Quiescent supply current	V_{CC} = 5.5V; Outputs Low, V_I = GND or V_{CC}		12	15		15	mA
I _{CCZ}		V_{CC} = 5.5V; Outputs 3–State; V _I = GND or V _{CC}		65	250		250	μA
		Outputs enabled, one data input at 3.4V, other inputs at V _{CC} or GND; $V_{CC} = 5.5V$		0.5	1.5		1.5	mA
ΔI_{CC}	Additional supply current per input pin ²			250	μA			
		Outputs 3-State, one enable input at 3.4V, other inputs at V _{CC} or GND; $V_{CC} = 5.5V$		0.5	1.5		1.5	mA

DC ELECTRICAL CHARACTERISTICS

NOTES:

1. Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

2. This is the increase in supply current for each input at 3.4V. 3. This parameter is valid for any V_{CC} between 0V and 2.1V, with a transition time of up to10msec. From V_{CC} = 2.1V to V_{CC} = 5V \pm 10%, a transition time of up to 100µsec is permitted.

AC CHARACTERISTICS

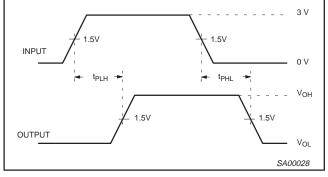
GND = 0V; $t_R = t_F$ = 2.5ns; C_L = 50pF, R_L = 500 Ω

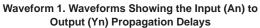
					LIMI	ſS		
SYMBOL	PARAMETER	WAVEFORM	T _a V	_{mb} = +25° _{CC} = +5.0	C V	$T_{amb} = -40^{\circ}$ $V_{CC} = +5.$	°C to +85°C .0V ±0.5V	UNIT
			Min	Тур	Мах	Min	Мах	
t _{PLH} t _{PHL}	Propagation delay An to Yn	1	1.0 1.0	2.9 3.0	4.2 4.3	1.0 1.0	4.4 4.6	ns
t _{PZH} t _{PZL}	Output enable time to High and Low level	2	1.9 1.9	3.2 4.4	5.8 5.9	1.9 1.9	6.5 6.5	ns
t _{PHZ} t _{PLZ}	Output disable time from High and Low level	2	1.0 1.0	4.2 2.9	5.2 4.9	1.0 1.0	5.8 5.5	ns

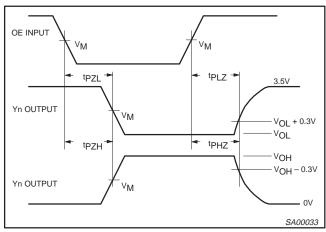
74ABT126

AC WAVEFORMS

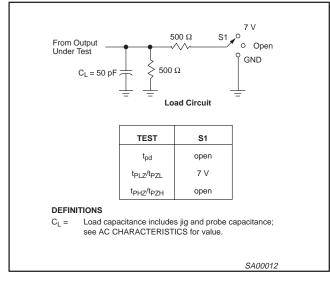
 V_{M} = 1.5V, V_{IN} = GND to 3.0V



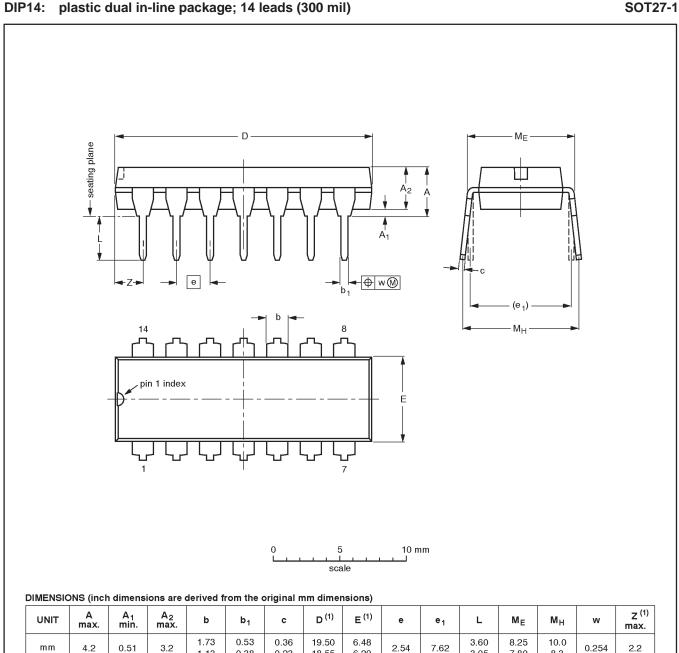




Waveform 2. Waveforms Showing the 3–State Output Enable and Disable Times



TEST CIRCUIT AND WAVEFORMS



DIP14: plastic dual in-line package; 14 leads (300 mil)

e

inches

0.17

0.020

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

0.13

1.13

0.068

0.044

0.38

0.021

0.015

0.23

0.014

0.009

18.55

0.77

0.73

6.20

0.26

0.24

0.10

0.30

3.05

0.14

0.12

7.80

0.32

0.31

8.3

0.39

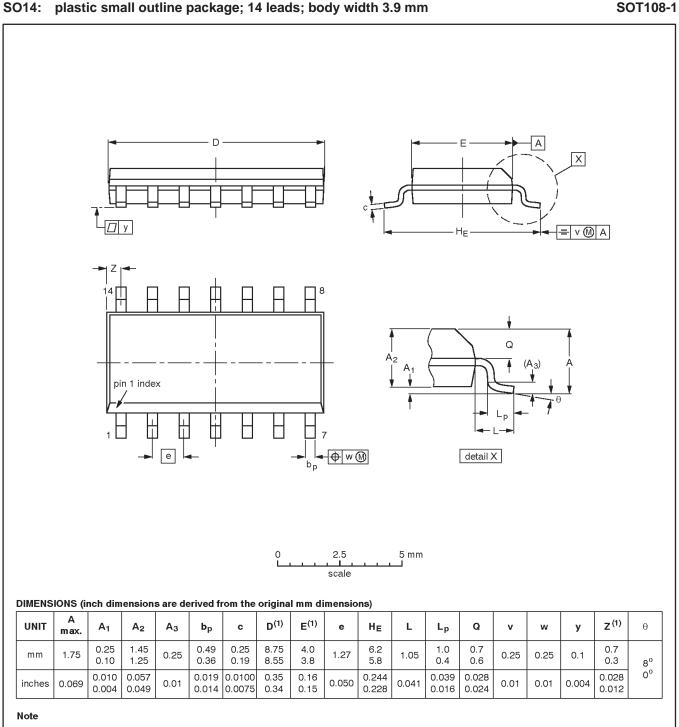
0.33

0.01

0.087

OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION	
SOT27-1	050G04	MO-001AA				-92-11-17 95-03-11

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1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

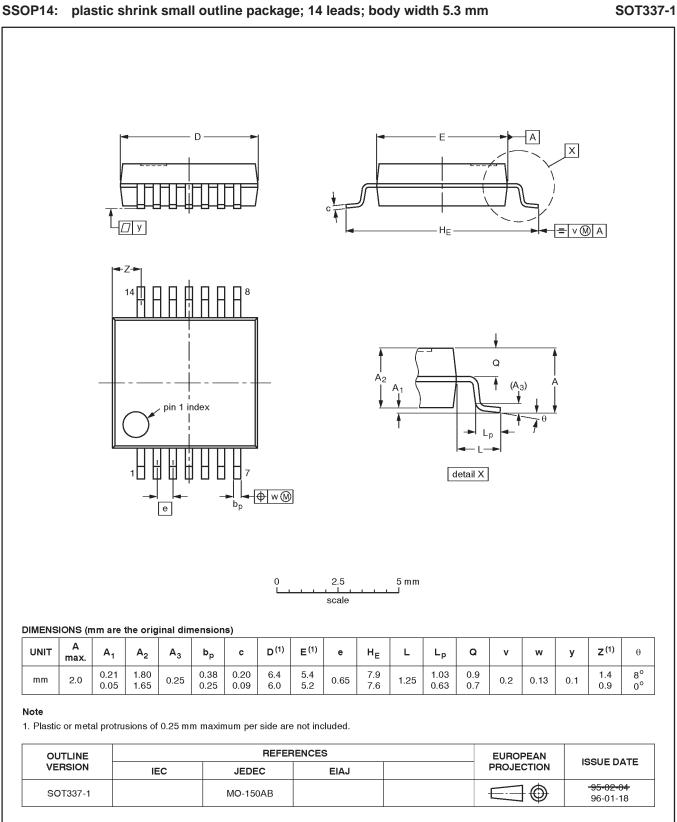
OUTLINE	REFERENCES EUROPEAN LISS				ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION	
SOT108-1	076E06S	MS-012AB				-95-01-23 97-05-22

Product specification

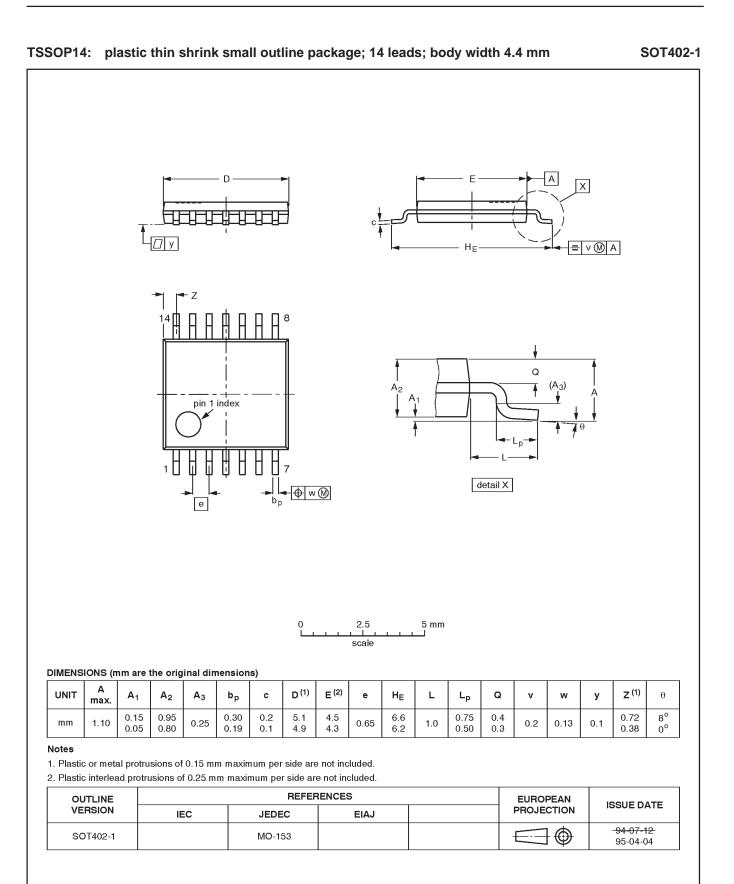
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DEFINITIONS					
Data Sheet Identification	Product Status	Definition			
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.			
		This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.			
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